

DP 1608 Series

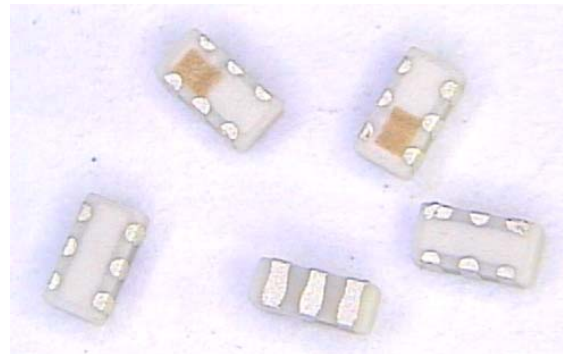
Multilayer Chip Diplexers

Features

- ❖ Monolithic structure including one low-pass and one high-pass filters with loss pole at adjacent passband.
- ❖ RoHS compliant

Applications

- ❖ Dual-band / dual-mode at 1.5GHz and 2.4GHz.



Specifications

Part Number	Passband (MHz)	Insertion Loss (dB)		Passband VSWR	Attenuation (dB)
DP1608-V1524AA_	1550~1580	0.6 max.	0.47 typ.	2.0 max.	12 min. @2400~2500MHz
	1594~1610	0.7 max.	0.54 typ.		12 min. @4900~6000MHz
	2400~2500	0.7 max.	0.57 typ.	2.0 max.	20 min. @1550~1610MHz
	4900~6000	0.6 max.	0.43 typ.	2.0 max.	

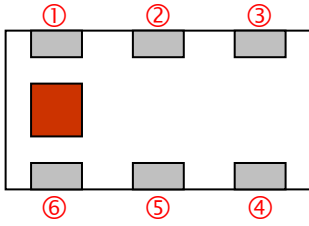
Q'ty/Reel (pcs) : 4,000
 Operating Temperature Range : -40 ~ +85 °C
 Storage Temperature Range : -40 ~ +85 °C
 Storage Period : 12 months max.
 Power Capacity : 2W max.

Part Number

DP 1608 - V 1524 AA □ /LF
 ① ② ③ ④ ⑤ ⑥ ⑦

① Type	DP : Diplexer	② Dimensions (L x W)	1.6 x 0.8 mm
③ Material Code	V	④ Frequency Range	1524=1500MHz/2400MHz
⑤ Specification Code	AA	⑥ Packaging	T: Tape & Reel B: Bulk
⑦ Soldering	/LF=lead-free		

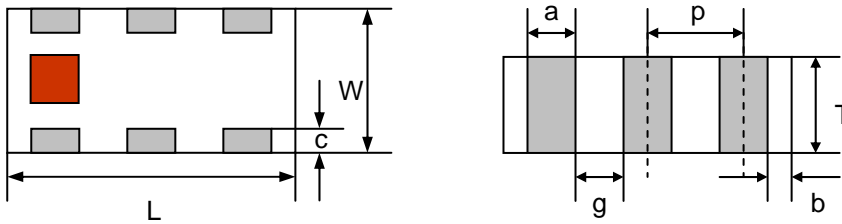
Terminal Configuration



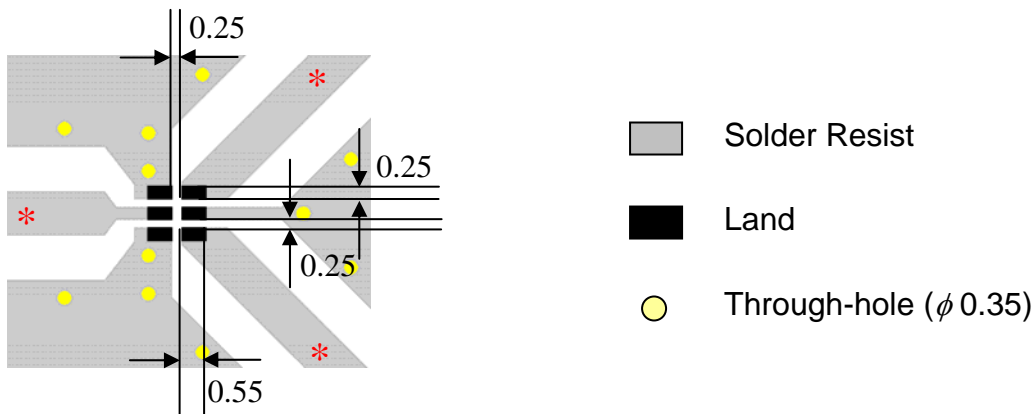
No.	Terminal Name	No.	Terminal Name
①	Lower Freq. Port	④	GND
②	GND	⑤	Common Port
③	Higher Freq. Port	⑥	GND

Dimensions and Recommended PC Board Pattern

Unit : mm

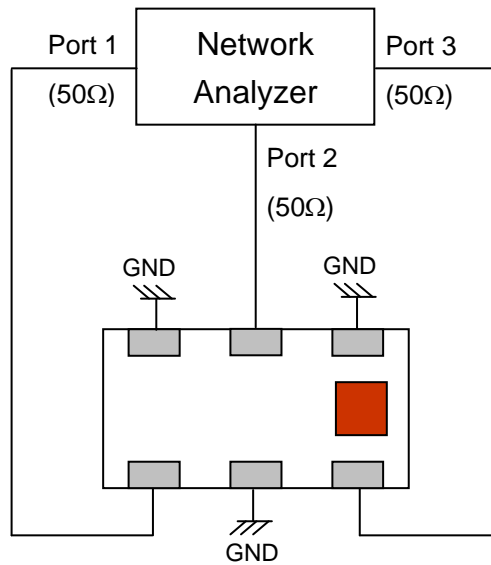


Mark	L	W	T	a	b	c	g	p
Dimensions	1.6 ±	0.8 ±	0.6 ±	0.2 ±	0.2+0.1	0.15 ±	0.3 ±	0.50 ±
	0.1	0.1	0.1	0.1	-0.15	0.1	0.1	0.05

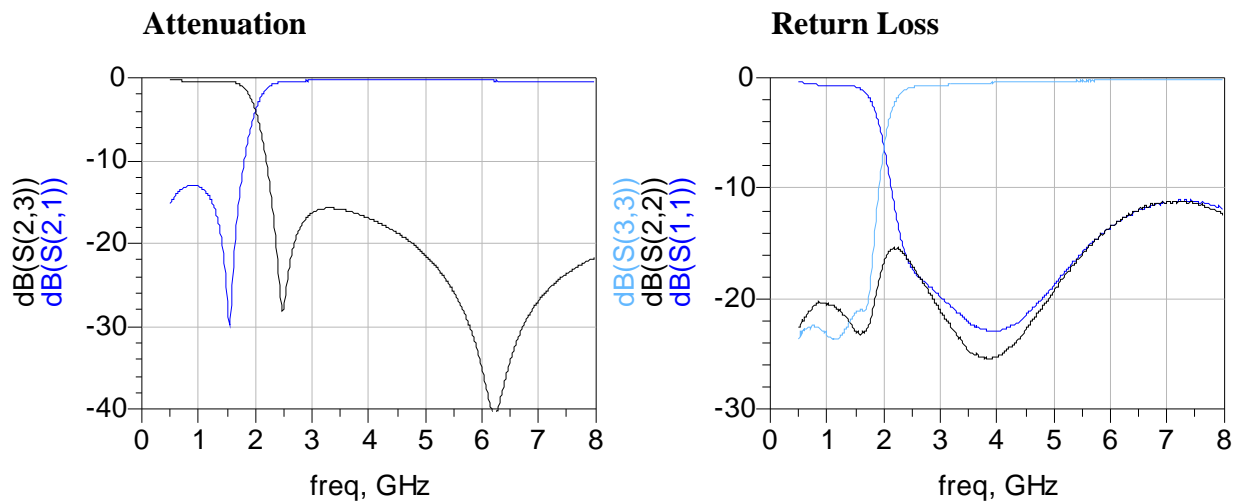


* Line width should be designed to match 50 Ω characteristic impedance, depending on PCB material and thickness.

Measuring Diagram



Typical Electrical Characteristics (T=25°C)

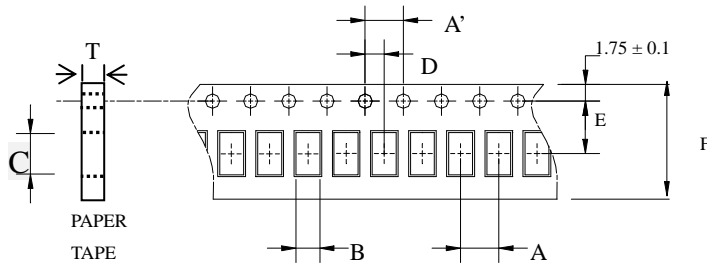


Notes

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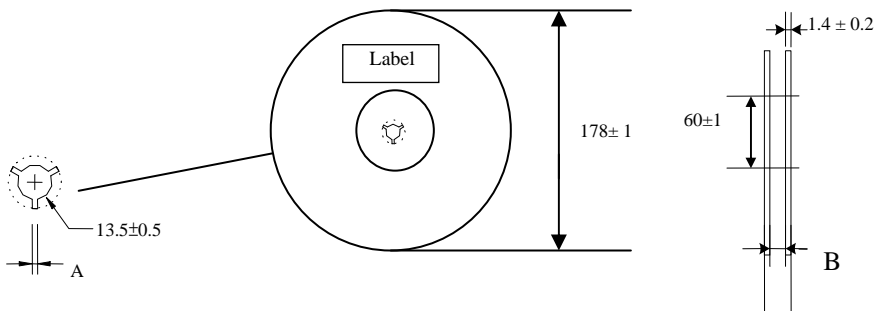
Taping Specifications

❖Tape Dimensions (Unit: mm) & Quantity



Type	A	A'	B	C	D	E	F	T	Quantity/reel	Tape material
1608	4.0±	4.0±	1.10±	1.92±	2.0±	3.5±	8.0±	0.75±	4,000pcs	Paper
	0.1	0.1	0.1	0.1	0.1	0.1	0.1	0.05		

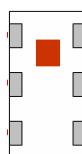
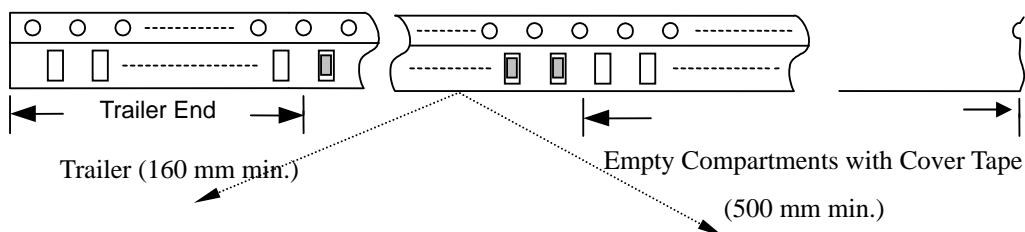
❖Reel Dimensions (Unit: mm)



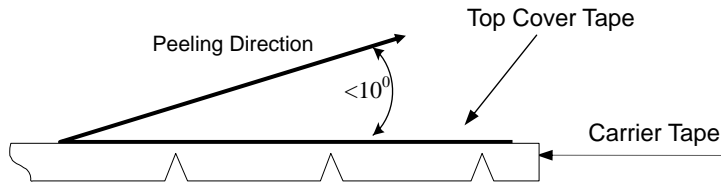
Label: Customer's Name,
ACX P/N, Q'ty, Date,
ACX Corp.

Type	A	B
1608	2.3±0.5	9.0±0.3

❖Leader and Trailer Tape (Plastic material)



❖ **Peel-off Force**



Peel-off force should be in the range of 0.1 – 0.6 N at a peel-off speed of 300 ± 10 mm/min .

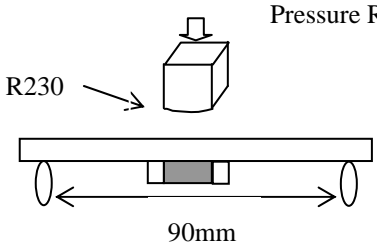
❖ **Storage Conditions**

- (1) Temperature: 5 ~35°C , relative humidity (RH): 45~75%.
- (2) Non-corrosive environment.

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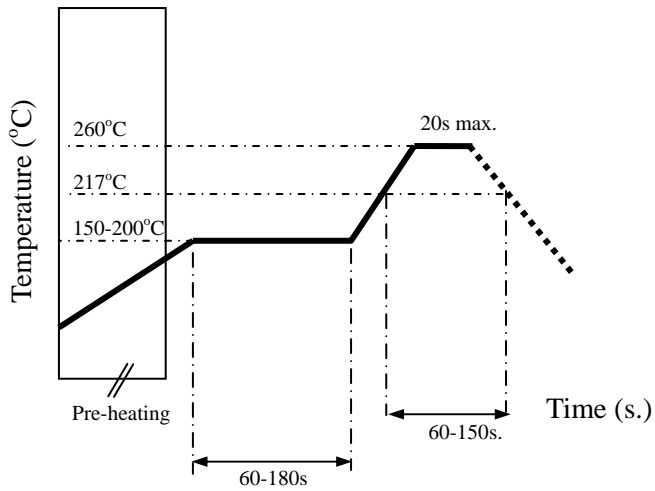
Mechanical & Environmental Characteristics

Item	Requirements	Procedure
Solderability	<ol style="list-style-type: none"> No apparent damage More than 95% of the terminal electrode shall be covered with new solder 	<ol style="list-style-type: none"> Preheat: $120 \pm 5^\circ\text{C}$ Solder: $245 \pm 5^\circ\text{C}$ for 5 ± 1 sec
Soldering strength (Termination Adhesion)	<ol style="list-style-type: none"> 1kg minimum 	<ol style="list-style-type: none"> Solder specimen onto test jig. Apply push force at 0.5mm/s until electrode pads are peeled off or ceramic are broken. Pushing force is applied to longitude direction
Deflection (Substrate Bending)	<ol style="list-style-type: none"> No apparent damage 	<ol style="list-style-type: none"> Solder specimen onto test jig (FR4, 0.8mm) using the recommend soldering profile. Apply a bending force of 2mm deflection. 
Heat/Humidity Resistance	<ol style="list-style-type: none"> No apparent damage Fulfill the electrical specification after test 	<ol style="list-style-type: none"> Temperature: $85 \pm 2^\circ\text{C}$ Humidity: 90% ~ 95% RH Duration: 1000 ± 48hrs Recovery: 1-2hrs
Thermal shock (Temperature Cycle)	<ol style="list-style-type: none"> No apparent damage Fulfill the electrical specification after test 	<ol style="list-style-type: none"> One cycle/step 1 : $125 \pm 5^\circ\text{C}$ for 30 min step 2 : $-40 \pm 5^\circ\text{C}$ for 30 min No of cycles : 100 Recovery: 1-2 hrs
Low Temperature Resistance	<ol style="list-style-type: none"> No apparent damage Fulfill the electrical specification after test 	<ol style="list-style-type: none"> Temperature: $-40 \pm 5^\circ\text{C}$ Duration: 500 ± 24hrs Recovery: 1-2hrs

Soldering Conditions

❖ Typical Soldering Profile for Lead-free Process

Reflow Soldering :



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